



DNK1111R

Surface Mount IRED/Reverse Mount Type

Features

Package	3216 Reverse Mount type, Water clear epoxy
Product features	 Outer Dimension 3.2 x 1.6 x 1.1mm (LxWxH) Flat Lenz type Total Output Power DNK : 8.3mW TYP. (I_F=20mA) Reverse Mount type Lead-free soldering compatible RoHS compliant
Peak Wavelength	DNK : 865nm
Half Intensity Angle	DNK : 155 deg.
Die materials	GaAlAs (DNK)
Rank grouping parameter	Sorted by radiant intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering Please refer to Soldering Conditions about soldering.
Taping and reel	3,000pcs per reel in a 8mm width tape. (Standard) Reel diameter:φ180mm
ESD-withstand voltage	2kV (HBM)

Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications





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Color and Luminous Intensity

(Ta=25)

Part No.	Material	Lens Color	Peak Wavelength λ _p (nm)		Radiant Intensity		
		TYP.	I _F (mA)	MIN.	TYP.	I _F (mA)	
DNK1111R	GaAlAs	Water Clear	865	20	0.7	1.4	20







Absolute Maximum Ratings

(Ta=25)

Item	Symbol	ute Maximum Ra	Unit	
item	Syllibol	DNK	Oilit	
Power Dissipation	P _d	80	mW	
Forward Current	I _F	50	mA	
Pulse Forward Current **1	I _{FRM}	300	mA	
Derating	⊿I _F	0.67	mA/℃	
(Ta=25℃ or higher)	⊿I _{FRM}	4.00	m A /℃	
Reverse Voltage	V _R	5	V	
Operating Temperature	T _{opr}	-30~+85	င	
Storage Temperature	T _{stg}	-40~+100	င	

¹ I_{FRM} Measurement condition : Pulse Width 100 μ s, Duty 1/100

Electro-Optical Characteristics

(Ta=25)

lte un	Sumb		Characteristics		11.24
Item	Conditions	Symbol		DNK	Unit
Forward Voltage	I _F =20mA	V _F	TYP.	1.40	v
i oiwaiu voitage	IF-ZUIIA	VF	MAX.	1.65	•
Reverse Current	V _R =5V	I _R	MAX.	100	μΑ
Radiant Intensity	I _F =20mA	IE	MIN.	0.7	mW/sr
Radiant intensity			TYP.	1.4	
Total Output Power	I _F =20mA	Ро	TYP.	8.3	mW
Peak Wavelength	I _F =20mA	λ _p	TYP.	865	nm
Spectral Half-width	I _F =20mA	⊿λ	TYP.	45	nm
Half Intensity Angle	I _F =20mA	201/2	TYP.	155	deg.
Cut off Eromuonov	I _F =20mA _{DC} ±5mA, -3db from 0.1MHz	fc	MIN.	-	MHz
Cut-off Frequency			TYP.	50	IVITIZ
Response Time	I _F =20mA	tr/tf	TYP.	7	ns



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Radiant Intensity Rank

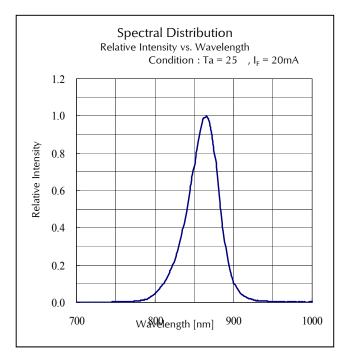
(Ta=25)

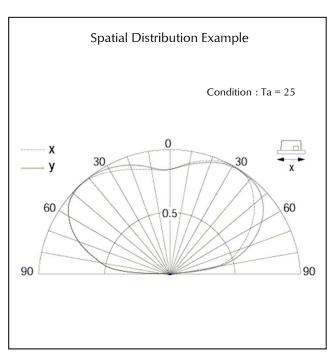
Rank	I _E (mW/sr) DNK		
	I _F =20mA		
	MIN.	MAX.	
Α	0.7	1.4	
В	1.0	2.0	
C	1.4	2.8	
D	2.0	4.0	
E	2.8	5.6	

Please contact our sales staff concerning rank designation.

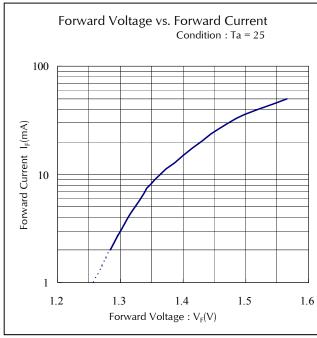


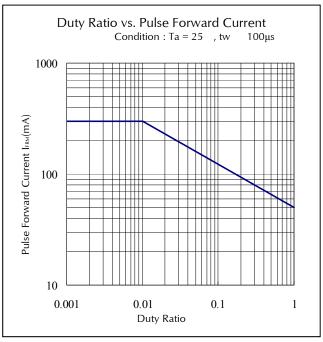
Technical Data (DNK)





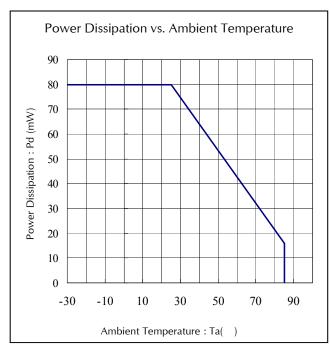
Pb-free HEAT

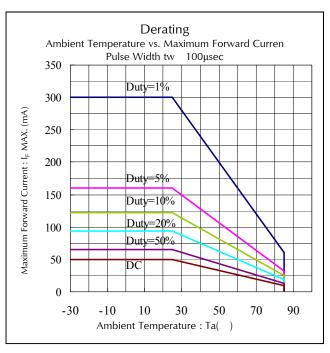




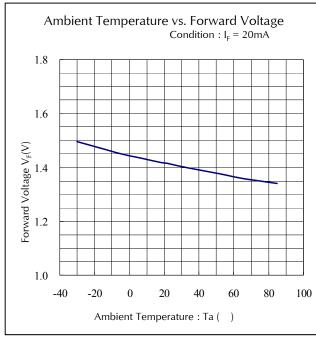


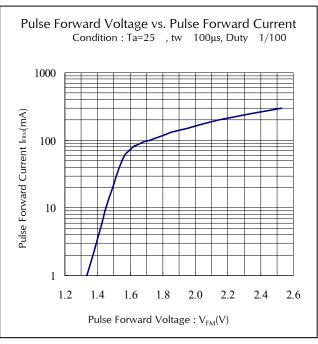
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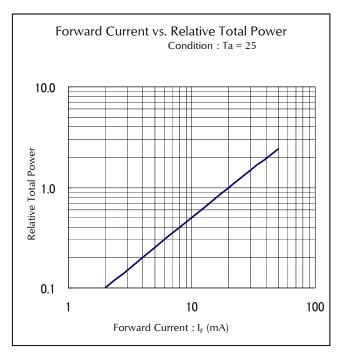
Pb-free HEAT

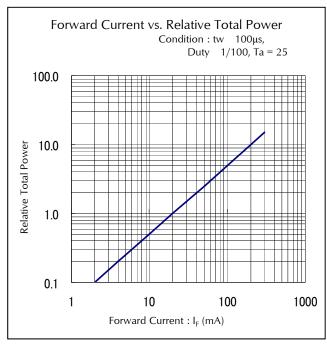




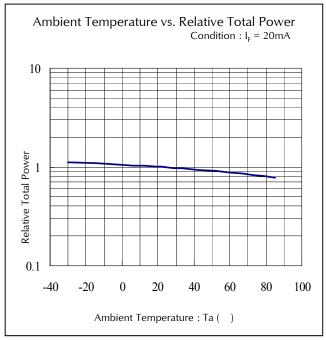


Technical Data (DNK)





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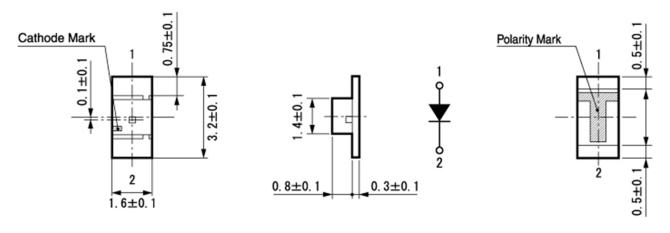
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Surface Mount IRED/Reverse Mount Type

Package Dimensions

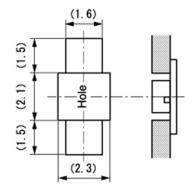
(Unit: mm)

Weight: (6.60)mg



Recommended Soldering Pattern

(Unit: mm)

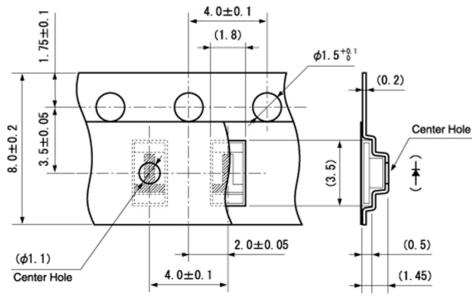


Taping Specification

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(Unit: mm)

Quantity: 3,000pcs/ reel (standard)

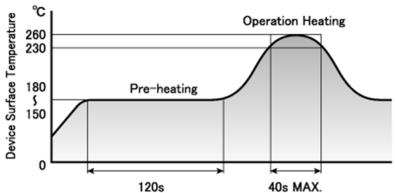


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Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp.	350	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)



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Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°C~180°C 120s Operating Heating 230°C Min. Peak temperature 260°C	Twice	0/25
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) Normal Temperature(15min) Maximum Rated Storage Temperature(30min) Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$Ta = 60 \pm 2$ °C, RH = 90 ± 5 %	1,000 h	0/25
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Radiant Intensity	I _E	IF Value of each product Radiant Intensity	Testing Min. Value < Initial Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value > Spec. Max. Value x 1.2
Reverse Current	I R	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5



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